

# FXLA102

## Low Voltage Dual Supply 2-Bit Voltage Translator with Configurable Voltage Supplies and Signal Levels, 3-State Outputs, and Auto Direction Sensing

### Features

- Bi-directional interface between two levels from 1.1V to 3.6V.
- Fully configurable: Inputs and outputs track  $V_{CC}$  level.
- Non-preferential power-up; either  $V_{CC}$  may be powered-up first.
- Outputs remain in 3-state until active  $V_{CC}$  level is reached.
- Outputs switch to 3-state if either  $V_{CC}$  is at GND.
- Power off protection
- Bushold on data inputs eliminates the need for pull-up or pull-down resistors
- Control input ( $\overline{OE}$ ) is referenced to  $V_{CCA}$  voltage.
- Packaged in 8-terminal leadless MicroPak (1.6mm x 1.6mm)
- Direction control not needed.
- 100 Mbps throughput when translating between 1.8V and 2.5V.
- ESD protection exceeds:
  - 15kV HBM (B port I/O to GND) (per JESD22-A114 & Mil Std 883e 3015.7)
  - 8kV HBM (A port I/O to GND) (per JESD22-A114 & Mil Std 883e 3015.7)
  - 2kV CDM (per ESD STM 5.3)

### General Description

The FXLA102 is a configurable dual-voltage-supply translator designed for both uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6V to as low as 1.1V. The A port tracks the  $V_{CCA}$  level, and the B port tracks the  $V_{CCB}$  level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2V, 1.5V, 1.8V, 2.5V and 3.3V.

The device remains in 3-state until both VCCs reach active levels, allowing either  $V_{CC}$  to be powered-up first. Internal power down control circuits place the device in 3-state if either  $V_{CC}$  is removed.

The  $\overline{OE}$  input, when high, disables both the A and B ports by placing them in a 3-state condition. The  $\overline{OE}$  input is supplied by  $V_{CCA}$ .

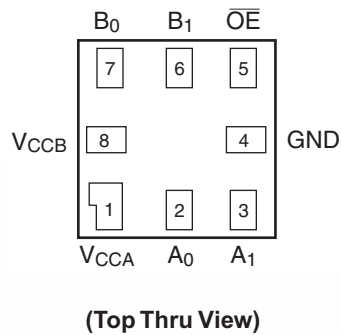
The FXLA102 supports bi-directional translation without the need for a direction control pin. The two ports of the device have auto-direction sense capability. Either port may sense an input signal and transfer it as an output signal to the other port.

### Ordering Information

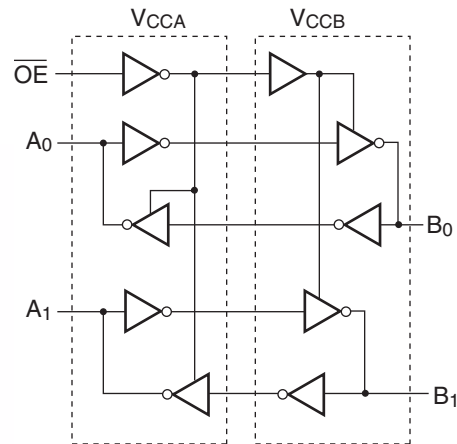
Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
FXLA102L8X	MAC08A	XF	8-Lead MicroPak, 1.6mm Wide	3k Units on Tape and Reel

 All packages are lead free per JEDEC: J-STD-020B standard.

### Connection Diagram



### Functional Diagram



### Pin Description

Number	Name	Description
1	V <sub>CCA</sub>	A Side Power Supply
2, 3	A <sub>0</sub> , A <sub>1</sub>	A Side Inputs or 3-State Outputs
4	GND	
5	$\overline{OE}$	Output Enable Input
6, 7	B <sub>1</sub> , B <sub>0</sub>	A Side Inputs or 3-State Outputs
8	V <sub>CCB</sub>	B Side Power Supply

### Function Table

Control	Outputs
$\overline{OE}$	
L	Normal Operation
H	3-State

H = HIGH Logic Level

L = LOW Logic Level

### Power-Up/Power-Down Sequencing

FXL translators offer an advantage in that either V<sub>CC</sub> may be powered up first. This benefit derives from the chip design. When either V<sub>CC</sub> is at 0 volts, outputs are in a high-impedance state. The control input ( $\overline{OE}$ ) is designed to track the V<sub>CCA</sub> supply. A pull-up resistor tying  $\overline{OE}$  to V<sub>CCA</sub> should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up/power-down. The size of the pull-up resistor is based upon the current-sinking capability of the device driving the  $\overline{OE}$  pin.

The recommended power-up sequence is the following:

1. Apply power to the first V<sub>CC</sub>.
2. Apply power to the second V<sub>CC</sub>.
3. Drive the  $\overline{OE}$  input LOW to enable the device.

The recommended power-down sequence is the following:

1. Drive  $\overline{OE}$  input HIGH to disable the device.
2. Remove power from either V<sub>CC</sub>.
3. Remove power from other V<sub>CC</sub>.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
$V_{CCA}, V_{CCB}$	Supply Voltage	-0.5V to +4.6V
$V_I$	DC Input Voltage I/O Port A I/O Port B Control Input ( $\overline{OE}$ )	-0.5V to +4.6V -0.5V to +4.6V -0.5V to +4.6V
$V_O$	Output Voltage <sup>(2)</sup> Outputs 3-STATE Outputs Active ( $A_n$ ) Outputs Active ( $B_n$ )	-0.5V to +4.6V -0.5V to $V_{CCA} + 0.5V$ -0.5V to $V_{CCB} + 0.5V$
$I_{IK}$	DC Input Diode Current @ $V_I < 0V$	-50mA
$I_{OK}$	DC Output Diode Current @ $V_O < 0V$ $V_O > V_{CC}$	-50mA +50mA
$I_{OH}/I_{OL}$	DC Output Source/Sink Current	-50mA / +50mA
$I_{CC}$	DC $V_{CC}$ or Ground Current per Supply Pin	$\pm 100mA$
$T_{STG}$	Storage Temperature Range	-65°C to +150°C

**Note:**

1.  $I_O$  Absolute Maximum Rating must be observed.

## Recommended Operating Conditions<sup>(2)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
$V_{CCA}$ or $V_{CCB}$	Power Supply Operating	1.1V to 3.6V
$V_I$	Input Voltage I/O Port A I/O Port B Control Inputs( $\overline{OE}$ )	0.0V to 3.6V 0.0V to 3.6V 0.0V to $V_{CCA}$
	Dynamic Output Current $I_{OH}/I_{OL}$ with $V_{CC}$ @ 3.0V to 3.6V 2.3V to 2.7V 1.65V to 1.95V 1.4V to 1.65V 1.1V to 1.4V	$\pm 12.0mA$ $\pm 8.0mA$ $\pm 5.0mA$ $\pm 3.0mA$ $\pm 2.0mA$
	Static Output Current $I_{OH}/I_{OL}$ with $V_{CC}$ @ 1.1V to 3.6V	$\pm 4.0\mu A$
$T_A$	Free Air Operating Temperature	-40°C to +85°C
$\Delta t/\Delta V$	Maximum Input Edge Rate $V_{CCA/B} = 1.1V$ to 3.6V	10ns/V

**Note:**

2. All unused inputs and I/O pins must be held at  $V_{CCI}$  or GND.

**DC Electrical Characteristics** ( $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ )

Symbol	Parameter	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Conditions	Min.	Typ.	Max.	Units
V <sub>IHA</sub>	High Level Input Voltage	2.7–3.6	1.1–3.6	Data inputs A <sub>n</sub> , Control Input $\overline{\text{OE}}$	2.0			V
		2.3–2.7			1.6			
		1.65–2.3			0.65 x V <sub>CCA</sub>			
		1.4–1.65			0.65 x V <sub>CCA</sub>			
		1.1–1.4			0.9 x V <sub>CCA</sub>			
V <sub>IHB</sub>		1.1–3.6	2.7–3.6	Data Inputs B <sub>n</sub>	2.0			V
		2.3–2.7			1.6			
		1.65–2.3			0.65 x V <sub>CCB</sub>			
		1.4–1.65			0.65 x V <sub>CCB</sub>			
		1.1–1.4			0.9 x V <sub>CCB</sub>			
V <sub>ILA</sub>	Low Level Input Voltage	2.7–3.6	1.1–3.6	Data Inputs A <sub>n</sub> , Control Input $\overline{\text{OE}}$			0.8	V
		2.3–2.7					0.7	
		1.65–2.3					0.35 x V <sub>CCA</sub>	
		1.4–1.65					0.35 x V <sub>CCA</sub>	
		1.1–1.4					0.1 x V <sub>CCA</sub>	
V <sub>ILB</sub>		1.1–3.6	2.7–3.6	Data Inputs B <sub>n</sub>			0.8	V
		2.3–2.7					0.7	
		1.65–2.3					0.35 x V <sub>CCB</sub>	
		1.4–1.65					0.35 x V <sub>CCB</sub>	
		1.1–1.4					0.1 x V <sub>CCB</sub>	
V <sub>OHA</sub> <sup>(3)</sup>	High Level Output Voltage	1.1–3.6	1.1–3.6	I <sub>OH</sub> = -4μA	V <sub>CCA</sub> - 0.4			V
V <sub>OHB</sub> <sup>(3)</sup>	Output Voltage	1.1–3.6	1.1–3.6	I <sub>OH</sub> = -4μA	V <sub>CCB</sub> - 0.4			V
V <sub>OLA</sub> <sup>(3)</sup>	Low Level Output Voltage	1.1–3.6	1.1–3.6	I <sub>OL</sub> = 4μA			0.4	V
V <sub>OLB</sub> <sup>(3)</sup>	Output Voltage	1.1–3.6	1.1–3.6	I <sub>OL</sub> = 4μA			0.4	V
I <sub>I(HOLD)</sub>	Bushold Input Minimum Drive Current	3.0	3.0	V <sub>IN</sub> = 0.8V	75.0			μA
		3.0	3.0	V <sub>IN</sub> = 2.0V	-75.0			
		2.3	2.3	V <sub>IN</sub> = 0.7V	45.0			
		2.3	2.3	V <sub>IN</sub> = 1.6V	-45.0			
		1.65	1.65	V <sub>IN</sub> = 0.57V	25.0			
		1.65	1.65	V <sub>IN</sub> = 1.07V	-25.0			
		1.4	1.4	V <sub>IN</sub> = 0.49V	11.0			
		1.4	1.4	V <sub>IN</sub> = 0.91V	-11.0			
		1.1	1.1	V <sub>IN</sub> = 0.11V		4		
1.1	1.1	V <sub>IN</sub> = 0.99V		-4				
I <sub>I(ODH)</sub> <sup>(4)</sup>	Bushold Input Overdrive High Current	3.6	3.6	Data Inputs A <sub>n</sub> , B <sub>n</sub>	450			μA
		2.7	2.7		300			
		1.95	1.95		200			
		1.6	1.6		120			
		1.4	1.4		80			
I <sub>I(ODL)</sub> <sup>(5)</sup>	Bushold Input Overdrive Low Current	3.6	3.6	Data Inputs A <sub>n</sub> , B <sub>n</sub>	-450			μA
		2.7	2.7		-300			
		1.95	1.95		-200			
		1.6	1.6		-120			
		1.4	1.4		-80			

**DC Electrical Characteristics** ( $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ) (Continued)

Symbol	Parameter	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Conditions	Min.	Typ.	Max.	Units
I <sub>I</sub>	Input Leakage Current	1.1–3.6	3.6	Control input $\overline{\text{OE}}$ , V <sub>I</sub> = V <sub>CCA</sub> or GND			±1.0	μA
I <sub>OFF</sub>	Power Off Leakage Current	0	3.6	A <sub>n</sub> Port, V <sub>O</sub> = 0V to 3.6V			±2.0	μA
		3.6	0	B <sub>n</sub> Port, V <sub>O</sub> = 0V to 3.6V			±2.0	μA
I <sub>OZ</sub>	3-State Output Leakage	3.6	3.6	Data Outputs A <sub>n</sub> , B <sub>n</sub> V <sub>O</sub> = 0V or 3.6V, $\overline{\text{OE}} = V_{IH}$			±5.0	μA
		3.6	0	Data outputs A <sub>n</sub> , V <sub>O</sub> = 0V or 3.6V, $\overline{\text{OE}} = \text{GND}$			±5.0	μA
		0	3.6	Data outputs B <sub>n</sub> V <sub>O</sub> = 0V or 3.6V, $\overline{\text{OE}} = \text{GND}$			±5.0	μA
I <sub>CCA/B</sub> <sup>(6)(7)</sup>	Quiescent Supply Current	1.1–3.6	1.1–3.6	V <sub>I</sub> = V <sub>CC1</sub> or GND, I <sub>O</sub> = 0, $\overline{\text{OE}} = \text{GND}$			10.0	μA
I <sub>CCZ</sub> <sup>(6)(7)</sup>	Quiescent Supply Current	1.1–3.6	1.1–3.6	V <sub>I</sub> = V <sub>CC1</sub> or GND, I <sub>O</sub> = 0, $\overline{\text{OE}} = V_{IH}$			10.0	μA
I <sub>CCA</sub>	Quiescent Supply Current	0	1.1–3.6	V <sub>I</sub> = V <sub>CCB</sub> or GND, I <sub>O</sub> = 0, B-to-A Direction, $\overline{\text{OE}} = \text{GND}$			-10.0	μA
		1.1–3.6	0				10.0	μA
I <sub>CCB</sub>	Quiescent Supply Current	1.1–3.6	0	V <sub>I</sub> = V <sub>CCA</sub> or GND, I <sub>O</sub> = 0, A-to-B Direction, $\overline{\text{OE}} = \text{GND}$			-10.0	μA
		0	1.1–3.6				10.0	μA

**Notes:**

3. This is the output voltage for static conditions. Dynamic drive specifications are given in “Dynamic Output Electrical Characteristics.”
4. An external driver must source at least the specified current to switch LOW-to-HIGH.
5. An external driver must source at least the specified current to switch HIGH-to-LOW.
6. V<sub>CC1</sub> is the V<sub>CC</sub> associated with the input side.
7. Reflects current per supply, V<sub>CCA</sub> or V<sub>CCB</sub>.

## Dynamic Output Electrical Characteristics<sup>(8)</sup>

### A Port (An)

Output Load:  $C_L = 15\text{pF}$ ,  $R_L \geq 1\text{M}\Omega$  ( $C_{I/O} = 4\text{pF}$ )

Symbol	Parameter	$T_A = -40^\circ\text{C to } +85^\circ\text{C}, V_{CCA} =$									Units
		3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		1.4V to 1.6V		1.1V to 1.3V	
		Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	
$t_{\text{rise}}^{(9)}$	Output Rise Time A port		3.0		3.5		4.0		5.0	7.5	ns
$t_{\text{fall}}^{(10)}$	Output Fall Time A port		3.0		3.5		4.0		5.0	7.5	ns
$I_{\text{OHD}}^{(9)}$	Dynamic Output Current High	-11.4		-7.5		-4.7		-3.2		-1.7	mA
$I_{\text{OLD}}^{(10)}$	Dynamic Output Current Low	+11.4		+7.5		+4.7		+3.2		+1.7	mA

### B Port (Bn)

Output Load:  $C_L = 15\text{pF}$ ,  $R_L \geq 1\text{M}\Omega$  ( $C_{I/O} = 5\text{pF}$ )

Symbol	Parameter	$T_A = -40^\circ\text{C to } +85^\circ\text{C}, V_{CCB} =$									Units
		3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		1.4V to 1.6V		1.1V to 1.3V	
		Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	
$t_{\text{rise}}^{(9)}$	Output Rise Time B port		3.0		3.5		4.0		5.0	7.5	ns
$t_{\text{fall}}^{(10)}$	Output Fall Time B port		3.0		3.5		4.0		5.0	7.5	ns
$I_{\text{OHD}}^{(9)}$	Dynamic Output Current High	-12.0		-7.9		-5.0		-3.4		-1.8	mA
$I_{\text{OLD}}^{(10)}$	Dynamic Output Current Low	+12.0		+7.9		+5.0		+3.4		+1.8	mA

#### Notes:

8. Dynamic Output Characteristics are guaranteed but not tested.
9. See Figure 5.
10. See Figure 6.

## AC Characteristics

$V_{CCA} = 3.0V$  to  $3.6V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.2	3.5	0.3	3.9	0.5	5.4	0.6	6.8	10.0	ns
	B to A	0.2	3.5	0.2	3.8	0.3	5.0	0.5	6.0	7.0	ns
$t_{PZL}$ , $t_{PZH}$	$\overline{OE}$ to A, $\overline{OE}$ to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(11)}$	A Port, B Port		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 2.3V$  to  $2.7V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.2	3.8	0.4	4.2	0.5	5.6	0.8	6.9	10.5	ns
	B to A	0.3	3.9	0.4	4.2	0.5	5.5	0.5	6.5	7.0	ns
$t_{PZL}$ , $t_{PZH}$	$\overline{OE}$ to A, $\overline{OE}$ to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(11)}$	A Port, B Port		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 1.65V$  to  $1.95V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.3	5.0	0.5	5.5	0.8	6.7	0.9	7.5	11.0	ns
	B to A	0.5	5.4	0.5	5.6	0.8	6.7	1.0	7.0	7.0	ns
$t_{PZL}$ , $t_{PZH}$	$\overline{OE}$ to A, $\overline{OE}$ to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(11)}$	A Port, B Port		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 1.4V$  to  $1.6V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.5	6.0	0.5	6.5	1.0	7.0	1.0	8.5	11.5	ns
	B to A	0.6	6.8	0.8	6.9	0.9	7.5	1.0	8.5	9.0	ns
$t_{PZL}$ , $t_{PZH}$	$\overline{OE}$ to A, $\overline{OE}$ to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(11)}$	A Port, B Port		1.0		1.0		1.0		1.0	1.0	ns

### Note:

11. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (An, or Bn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is guaranteed but not tested. See Figure 8.

## AC Characteristics (Continued)

$V_{CCA} = 1.1V$  to  $1.3V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$					Units
		3.0V–3.6V	2.3V–2.7V	1.65V–1.95V	1.4V–1.6V	1.1V–1.3V	
		Typ.	Typ.	Typ.	Typ.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	7.1	6.5	7.0	7.1	13.5	ns
	B to A	10.3	10.5	10.8	11.3	13.5	ns
$t_{PZL}$ , $t_{PZH}$	$\overline{OE}$ to A, $\overline{OE}$ to B	1.7	1.7	1.7	1.7	1.7	$\mu s$
$t_{skew}^{(11)}$	A Port, B Port	1.0	1.0	1.0	1.0	1.0	ns

### Note:

11. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (An, or Bn) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). Skew is guaranteed but not tested. See Figure 8.

## Max Data Rate<sup>(12)(13)</sup>

$V_{CCA} =$	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$					Units
	3.0V to 3.6V	2.3V to 2.7V	1.65V to 1.95V	1.4V to 1.6V	1.1V to 1.3V	
	Min.	Min.	Min.	Min.	Typ.	
3.0V to 3.6V	140	120	100	80	40	Mbps
2.3V to 2.7V	120	120	100	80	40	Mbps
1.65V to 1.95V	100	100	80	60	40	Mbps
1.4V to 1.6V	80	80	60	60	40	Mbps
	Typ.	Typ.	Typ.	Typ.	Typ.	
1.1V to 1.3V	40	40	40	40	40	Mbps

### Note:

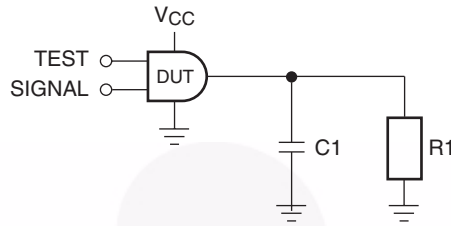
12. Max Data Rate is guaranteed but not tested.

13. Max Data Rate is specified in megabits per second. See Figure 7. It is equivalent to two times the F-toggle frequency, specified in megahertz. For example, 100 Mbps is equivalent to 50 MHz.

## Capacitance

Symbol	Parameter	Conditions	$T_A = +25^{\circ}C$	Units
			Typical	
$C_{in}$	Input Capacitance, Control pin ( $\overline{OE}$ )	$V_{CCA} = V_{CCB} = GND$	3	pF
$C_{i/o}$	Input/Output Capacitance	An	$V_{CCA} = V_{CCB} = 3.3V$ ,	4
		Bn	$\overline{OE} = V_{CCA}$	5
$C_{pd}$	Power Dissipation Capacitance	$V_{CCA} = V_{CCB} = 3.3V$ , $V_i = 0V$ or $V_{CC}$ , $f = 10MHz$	25	pF



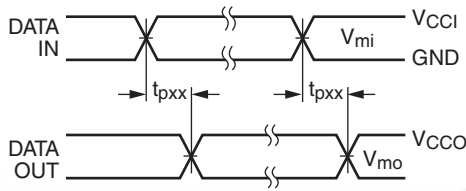


Test	Input Signal	Output Enable Control
$t_{PLH}$ , $t_{PHL}$	Data Pulses	0V
$t_{PZL}$	0V	HIGH to LOW Switch
$t_{PZH}$	$V_{CCI}$	HIGH to LOW Switch

Figure 1. AC Test Circuit

AC Load Table

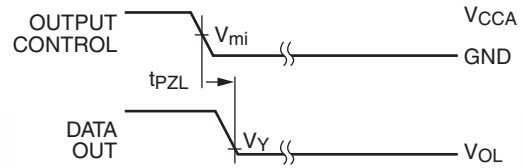
$V_{CCO}$	CI	RI
$1.2V \pm 0.1V$	15pF	1M $\Omega$
$1.5V \pm 0.1V$	15pF	1M $\Omega$
$1.8V \pm 0.15V$	15pF	1M $\Omega$
$2.5V \pm 0.2V$	15pF	1M $\Omega$
$3.3 \pm 0.3V$	15pF	1M $\Omega$



Input  $t_R = t_F = 2.0\text{ns}$ , 10% to 90%

Input  $t_R = t_F = 2.5\text{ns}$ , 10% to 90%, @  $V_i = 3.0\text{V}$  to  $3.6\text{V}$  only

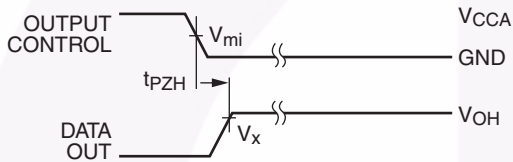
**Figure 2. Waveform for Inverting and Non-inverting Functions**



Input  $t_R = t_F = 2.0\text{ns}$ , 10% to 90%

Input  $t_R = t_F = 2.5\text{ns}$ , 10% to 90%, @  $V_i = 3.0\text{V}$  to  $3.6\text{V}$  only

**Figure 3. 3-STATE Output Low Enable Time for LOW Voltage Logic**



Input  $t_R = t_F = 2.0\text{ns}$ , 10% to 90%

Input  $t_R = t_F = 2.5\text{ns}$ , 10% to 90%, @  $V_i = 3.0\text{V}$  to  $3.6\text{V}$  only

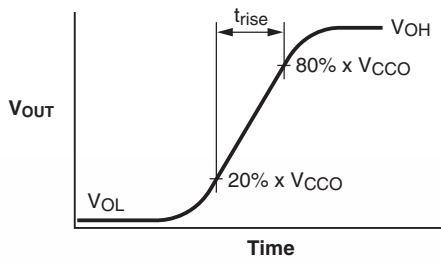
**Figure 4. 3-STATE Output High Enable Time for LOW Voltage Logic**

Symbol	$V_{CC}$
$V_{mi}^{(14)}$	$V_{CCI} / 2$
$V_{mo}$	$V_{CCO} / 2$
$V_X$	$0.9 \times V_{CCO}$
$V_Y$	$0.1 \times V_{CCO}$

**Note:**

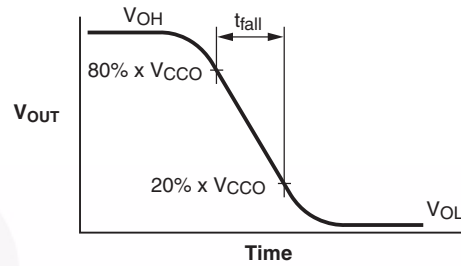
14.  $V_{CCI} = V_{CCA}$  for control pin  $\overline{OE}$  or  $V_{mi} = (V_{CCA} / 2)$ .





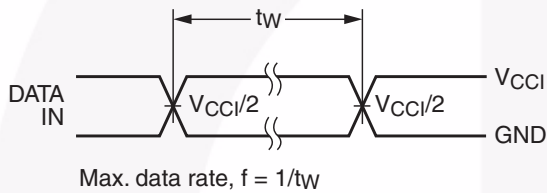
$$I_{OHD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(20\% - 80\%) \times V_{CCO}}{t_{RISE}}$$

**Figure 5. Active Output Rise Time and Dynamic Output Current HIGH**

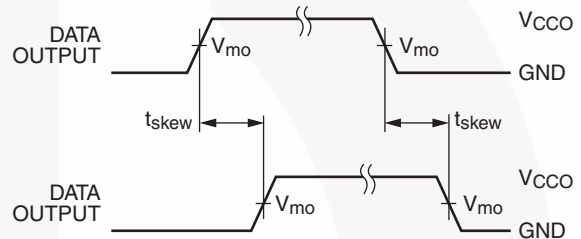


$$I_{OLD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(80\% - 20\%) \times V_{CCO}}{t_{FALL}}$$

**Figure 6. Active Output Fall Time and Dynamic Output Current LOW**



**Figure 7. Maximum Data Rate**



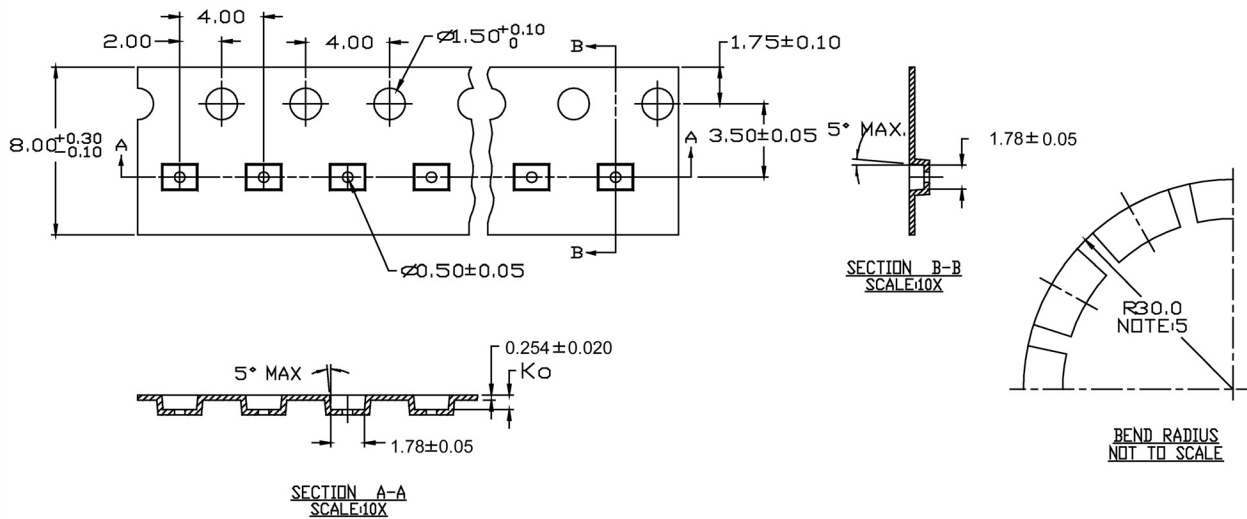
$$t_{skew} = (t_{pHLmax} - t_{pHLmin}) \text{ or } (t_{pLHmax} - t_{pLHmin})$$

**Figure 8. Output Skew Time**

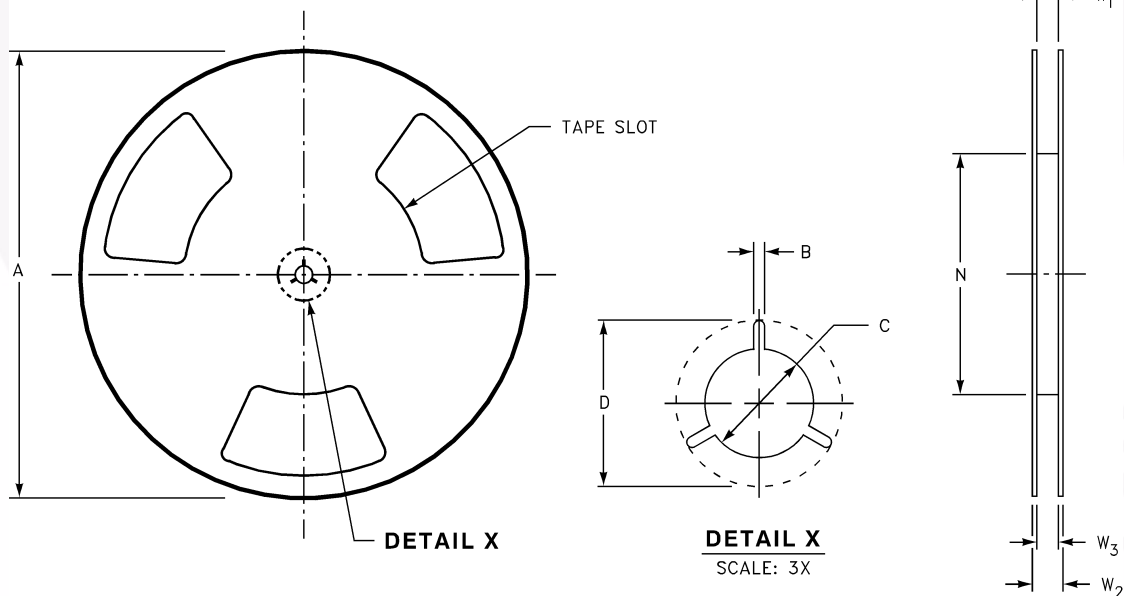
### Tape and Reel Dimensions

Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
L8X	Leader (Start End)	125 (typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ.)	Empty	Sealed

#### Tape Dimensions inches (millimeters)

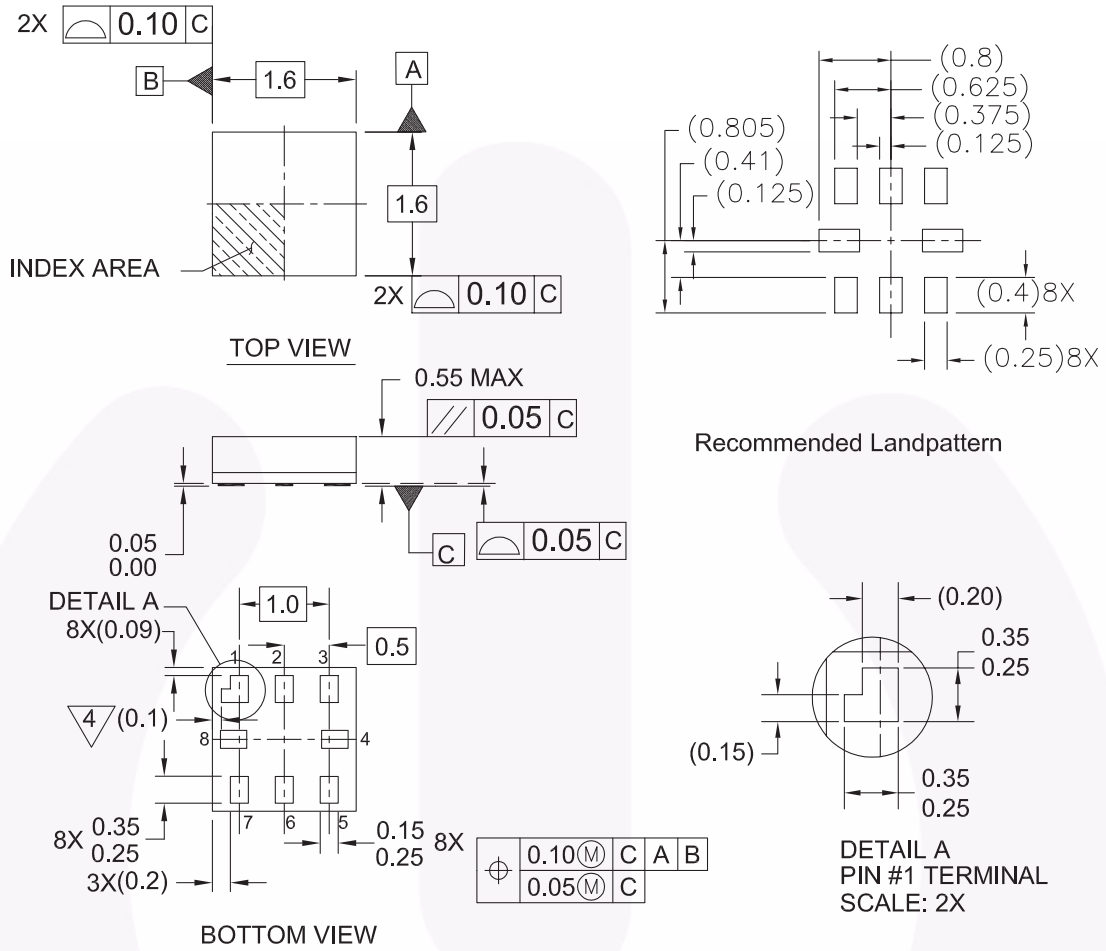


#### Reel Dimensions inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2	W3
8mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	$0.331 + 0.059 / - 0.000$ ( $8.40 + 1.50 / - 0.00$ )	0.567 (14.40)	$W1 + 0.078 / - 0.039$ ( $W1 + 2.00 / - 1.00$ )

## Physical Dimensions



### Notes:

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994
4. PIN 1 FLAG, END OF PACKAGE OFFSET
5. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

**Figure 9. 8-Lead MicroPak, 1.6mm Wide**

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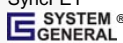
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| FACT®   | MotionMax™                          | SuperSOT™.3   | UniFET™   |
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| FastvCore™  | Motion-SPM™                         | SuperSOT™.8   | VisualMax™  |
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